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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO
10/765,894	01/29/2004	Yasuyuki Tamura	042069	2503
38834 75	590 08/23/2005		EXAMI	NER
	VESTERMAN, HATTORI, DANIELS & ADRIAN, LLP 250 CONNECTICUT AVENUE, NW		KIM, SU C	
SUITE 700	ATICOT AVENUE, NW		ART UNIT	PAPER NUMBER
WASHINGTO	N, DC 20036		2823	•
			DATE MAILED: 08/23/2005	:

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)	
Office Astinu O	10/765,894	TAMURA ET AL.	
Office Action Summary	Examiner	Art Unit	
	Su C. Kim	2823	
The MAILING DATE of this communicate Period for Reply	tion appears on the cover sheet w	ith the correspondence address	
A SHORTENED STATUTORY PERIOD FOR THE MAILING DATE OF THIS COMMUNIC. Extensions of time may be available under the provisions of after SIX (6) MONTHS from the mailing date of this communication of the period for reply specified above is less than thirty (30) of the period for reply is specified above, the maximum statute. Failure to reply within the set or extended period for reply will Any reply received by the Office later than three months after earned patent term adjustment. See 37 CFR 1.704(b).	ATION. 37 CFR 1.136(a). In no event, however, may a lication. lays, a reply within the statutory minimum of thir only period will apply and will expire SIX (6) MON, by statute, cause the application to become Al	reply be timely filed ty (30) days will be considered timely. JTHS from the mailing date of this communication. 3ANDONED (35 U.S.C. § 133).	
Status			
1) Responsive to communication(s) filed	on <u>29 <i>January</i> 2004</u> .	·	
2a) This action is FINAL . 2b	IX This action is non-final.		
3) Since this application is in condition for closed in accordance with the practice		*	
Disposition of Claims			
4) ⊠ Claim(s) 1-23 is/are pending in the apprending of the above claim(s) 12-23 is/are versions. 5) □ Claim(s) is/are allowed. 6) □ Claim(s) 1-11 is/are rejected. 7) ⊠ Claim(s) 1, 2, 6 & 7 is/are objected to. 8) □ Claim(s) are subject to restrictions.	withdrawn from consideration.		
Application Papers			
9) The specification is objected to by the E	Examiner.		
10)⊠ The drawing(s) filed on <u>29 January 200</u>	$\underline{4}$ is/are: a) \boxtimes accepted or b) \square o	bjected to by the Examiner.	
Applicant may not request that any objection			
Replacement drawing sheet(s) including th 11) The oath or declaration is objected to b			
Priority under 35 U.S.C. § 119			
12) Acknowledgment is made of a claim for a) All b) Some * c) None of: 1 Certified copies of the priority do 2. Certified copies of the priority do 3. Copies of the certified copies of application from the Internationa * See the attached detailed Office action f	cuments have been received. cuments have been received in A the priority documents have been I Bureau (PCT Rule 17.2(a)).	pplication No received in this National Stage	
Attachment(s)			
Notice of References Cited (PTO-892) Notice of Draftsperson's Patent Drawing Review (PTO3) Information Disclosure Statement(s) (PTO-1449 or PT Paper No(s)/Mail Date 4/29/2004.	-948) Paper No(Summary (PTO-413) s)/Mail Date nformal Patent Application (PTO-152) 	

DETAILED ACTION

Claim Objections

Claims 1, 2, 6, & 7 are objected to because of the following informalities: "High" dielectric is relative term, which require specification or describes what high means in the claim. Appropriate correction is required.

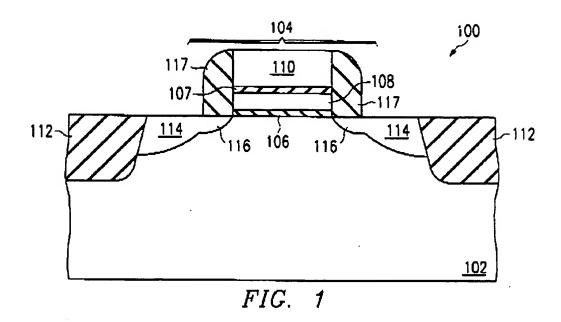
Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.

Claims 1 & 6 are rejected under 35 U.S.C. 102(b) as being anticipated by <u>Rodder</u> et al. (US 6251761).



Rodder discloses semiconductor device with multi-insulated layers as claimed.

See all the FIGS where Rodder teaches the following limitations

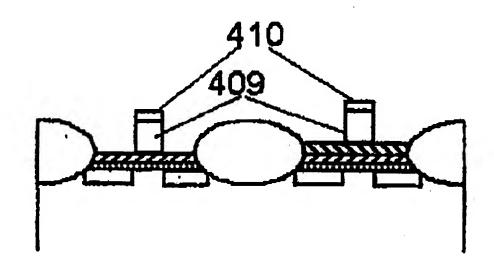
1. Pertaining to claims 1 & 6, Rodder discloses a semiconductor device comprising: a gate insulation film 106 108 & 107 which formed on a semiconductor substrate 102 and includes a silicon oxide- based insulation film 106, formed high dielectric constant film 108 formed on the silicon oxide-based insulation film, and an oxygen diffusion preventing 107 film formed on the high dielectric constant film and having a lower oxygen diffusion coefficient than the high dielectric constant film; and a gate electrode 110 formed on the gate insulation film.

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

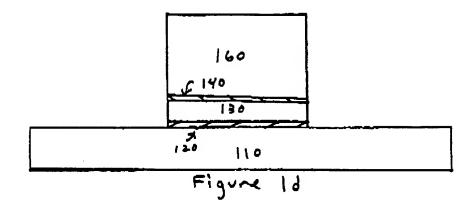
Claims 2- 7 are rejected under 35 U.S.C. 103(a) as being unpatentable over Watanabe (US Pub 20050167761) in view of Chau et al (US 6713358).

Fig. 4D



<u>Watanabe</u> discloses a semiconductor device as claimed. **See all the FIGS** where <u>Watanabe</u> teaches the following limitations

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<u>Chau</u> discloses a semiconductor device as claimed. **See all the FIGS** where <u>Chau</u> teaches the following limitations

2. Pertaining to claims 2 & 7, Watanabe discloses a semiconductor device comprising:

a first gate insulation film 403 formed on a first region of semiconductor substrate and including a silicon oxide-based insulation film 403(Please note element 403 is silicon oxide), a high dielectric constant film 404 (ZrO2) formed on the silicon oxide-based insulation film, and an oxygen diffusion preventing film 405(Please note element 405 is Zr silicate which is one of oxygen diffusion prevention film such as Hf silicate) formed on the high dielectric constant film and having a lower oxygen diffusion coefficient than the high dielectric constant film;

a first gate electrode 409 formed on the first gate insulation film;

a second gate insulation film formed on a second region of the semiconductor substrate and including the high dielectric constant film **404**

<u>Watanabe</u> fails to teach the oxygen diffusion preventing film formed on the high dielectric constant film. Chau discloses the oxygen diffusion preventing film 104 formed on the high dielectric constant film. In view of Chau, it would have been obvious to one of ordinary skill in the art to incorporate the process layer of Chau into the Watanabe because "adding nitrogen into a silicon oxidation film to form the gate insulator film having an increased dielectric constant compare with a pure silicon oxidation film and thereby reducing effective thickness of the gate insulator film without physically thinning the film thickness" (Column 1 and lines 42-49).

- 3. Pertaining to claim 3, <u>Watanabe</u> discloses a semiconductor device according to claim 1, wherein the high dielectric constant film **404** is hafnium oxide film or a zirconium oxide film.
- 4. Pertaining to claim 4, <u>Watanabe</u> discloses a semiconductor device according to claim 2, wherein the high dielectric constant film **404** is hafnium oxide film or a zirconium oxide film.

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5. Pertaining to claim 5, <u>Chau</u> discloses a semiconductor device according to claim 1, wherein oxygen diffusion preventing film **104** a silicon nitride film, an alumina film, an aluminum silicate film, a hafnium aluminate film or a hafnium silicate film.

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Claims 8-11 are rejected under 35 U.S.C. 103(a) as being unpatentable over Watanabe (US Pub 20050167761) further in view of Chau (US 6713358) and further in view of Yu (US 6784101).

- 6. Pertaining to claims 8-11, <u>Watanabe</u> further in view of <u>Chau</u> fails to discloses oxygen preventing film **104** hafnium aluminate film. <u>Yu</u> teaches using hafnium aluminate film as high dielectric film (**column 2 line 44-45**). In view of <u>Yu</u>, it would have been obvious to one of ordinary skill in the art to incorporate the high dielectric material of <u>Yu</u> into the Watanabe because "the increased capacitance permittivity of the gate dielectric material advantageously results in improved device performance" (**column 2 lines 20-23**).
- 7. Pertaining to claims 10-11, <u>Watanabe</u> further in view of <u>Chau & Yu</u> discloses dielectric material is hafnium aluminate film. <u>Watanabe</u> further in view of <u>Chau & Yu</u> fail to teach an alumina content ratio of the hafnium aluminate film is above 50 % including 50 %. However claims 10-11 are rejected under 35 U.S.C. 103 (a) as being unpatentable over <u>Watanabe</u> further in view of <u>Chau & Yu</u> and in view of optimum workable range.

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Given the teaching of the references, it would have been obvious to determine the optimum thickness, temperature as well as condition of delivery of the layers involved. See In re Aller, Lacey and Hall (10 USPQ 233-237) "It is not inventive to discover optimum or workable ranges by routine experimentation. Note that the specification contains no disclosure of either the critical nature of the claimed ranges or any unexpected results arising therefrom. Where patentability is said to be based upon particular chosen dimensions or upon another variable recited in a claim, the Applicant must show that the chosen dimensions are critical. *In re Woodru*; 919 f 2d 1575, 1578, 16 USPQ2d 1934, 1936 (Fed. Cir. 1990).

Any differences in the claimed invention and the prior art may be expected to result in some differences in properties. The issue is whether the properties differ to such an extent that the difference is really unexpected. *In re Merck & Co.*, 800 F.2d 1091, 231 USPQ 375 (Fed. Cir. 1986)

Appellants have the burden of explaining the data in any declaration they proffer as evidence of non-obviousness. *Ex parte Ishizake*, 24 USPQ2d 1621, 1624 (Bd. Pat. App. & Inter. 1992).

An Affidavit or declaration under 37 CFR 1.132 must compare the claimed subject matter with the closest prior art to be effective to rebut a prima facie case of obviousness. *In re Burckel*, 592 F.2d 1175, 201 USPQ 67 (CCPA 1979).

Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Su C. Kim whose telephone number is (571) 272-5972. The examiner can normally be reached on Monday - Friday, 8:30AM to 5:00PM.

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If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Matthew S. Smith can be reached on (571) 272-1907. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Su.C Kim 08/22/2005

> W. DAVID COLEMAN PRIMARY EXAMINER